



2827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Kevin K-T. CHUNG

:
:
: Art Unit: 2827

Appl. Serial No. 09/578,583

: Examiner: Tuan T. Dinh
:

Filed: May 25, 2000

For: **SOLDERABLE FLEXIBLE ADHESIVE INTERPOSER AS FOR AN
ELECTRONIC PACKAGE, AND METHOD FOR MAKING SAME**

7/B
P. Walker
10-17-02
RECEIVED
OCT 15 2002
TECHNOLOGY CENTER 2800

Certificate of Mailing Under 37 C.F.R. §1.8(a)

I hereby certify that this Correspondence, along with any paper referred to as being attached or enclosed, is being deposited on October 1, 2002 with the United States Postal Service with sufficient postage as first-class mail in an envelope addressed to ASSISTANT COMMISSIONER FOR PATENTS, WASHINGTON, DC 20231.

October 1, 2002
Date of Certificate

Jacqueline D. Bailey
Jacqueline D. Bailey

**REQUEST FOR CORRECTED OFFICE ACTION
AND PARTIAL RESPONSE**

This is a Response to the Office Letter mailed September 13, 2002 in the above-captioned Application for which the three-month statutory period for response expires December 13, 2002.

Because the Office Letter has an omission that precludes Applicant from making a response, Applicant hereby requests a corrected Action and restarting of the period for response because the request is made within one month of the mailing of the Office Letter.

In the interest of expediting prosecution, Applicant will attempt to respond at least in part. Please amend the captioned Application as follows:

In The Specification:

Please amend the specification to read as follows:

Paragraph beginning at page 6, line 29:

FIGURE 1 is a side cross-sectional schematic diagram of an exemplary embodiment of an electronic package 100 having a substrate 110 according to the

B1
cont'd